## 2N6667, 2N6668

# **Darlington Silicon Power Transistors**

Designed for general-purpose amplifier and low speed switching applications.

• High DC Current Gain -

 $h_{FE} = 3500 \text{ (Typ) } @ I_C = 4.0 \text{ Adc}$ 

• Collector-Emitter Sustaining Voltage - @ 200 mAdc

$$V_{CEO(sus)} = 60 \text{ Vdc (Min)} - 2N6667$$
  
= 80 Vdc (Min) - 2N6668

• Low Collector-Emitter Saturation Voltage -

 $V_{CE(sat)} = 2.0 \text{ Vdc (Max)} @ I_C = 5.0 \text{ Adc}$ 

- Monolithic Construction with Built-In Base-Emitter Shunt Resistors
- TO-220AB Compact Package
- Complementary to 2N6387, 2N6388
- These Devices are Pb-Free and are RoHS Compliant\*

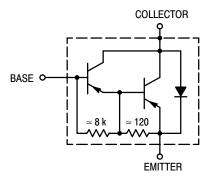


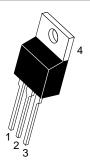
Figure 1. Darlington Schematic



#### ON Semiconductor®

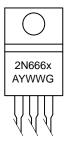
www.onsemi.com

PNP SILICON
DARLINGTON
POWER TRANSISTORS
10 A, 60–80 V, 65 W



TO-220 CASE 221A STYLE 1

#### **MARKING DIAGRAM**



x = 7 or 8

A = Assembly Location

Y = Year

WW = Work Week

G = Pb-Free Package

#### **ORDERING INFORMATION**

Device	Package	Shipping
2N6667G	TO-220 (Pb-Free)	50 Units/Rail
2N6668G	TO-220 (Pb-Free)	50 Units/Rail

<sup>\*</sup>For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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#### MAXIMUM RATINGS (Note 1)

Rating	Symbol	2N6667	2N6668	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	60	80	Vdc
Collector-Base Voltage	V <sub>CB</sub>	60	80	Vdc
Emitter-Base Voltage	V <sub>EB</sub>	5.0		Vdc
Collector Current - Continuous - Peak	I <sub>C</sub>	10 15		Adc
Base Current	Ι <sub>Β</sub>	250		mAdc
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	65 0.52		W W/°C
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	2.0 0.016		W W/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150		°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{ heta JC}$	1.92	°C/W
Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	62.5	°C/W

#### **ELECTRICAL CHARACTERISTICS** (Note 1) ( $T_C = 25$ °C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Sustaining Voltage (Note 2) (I <sub>C</sub> = 200 mAdc, I <sub>B</sub> = 0)	2N6667 2N6668	V <sub>CEO(sus)</sub>	60 80	-	Vdc
Collector Cutoff Current ( $V_{CE} = 60 \text{ Vdc}$ , $I_{B} = 0$ ) ( $V_{CE} = 80 \text{ Vdc}$ , $I_{B} = 0$ )	2N6667 2N6668	I <sub>CEO</sub>	_ _	1.0 1.0	mAdc
	2N6667 2N6668 2N6667 2N6668	I <sub>CEX</sub>	- - - -	300 300 3.0 3.0	μAdc mAdc
Emitter Cutoff Current (V <sub>BE</sub> = 5.0 Vdc, I <sub>C</sub> = 0)		I <sub>EBO</sub>	-	5.0	mAdc
ON CHARACTERISTICS (Note 1)					
DC Current Gain ( $I_C = 5.0$ Adc, $V_{CE} = 3.0$ Vdc) ( $I_C = 10$ Adc, $V_{CE} = 3.0$ Vdc)		h <sub>FE</sub>	1000 100	20000	-
Collector–Emitter Saturation Voltage ( $I_C = 5.0$ Adc, $I_B = 0.01$ Adc) ( $I_C = 10$ Adc, $I_B = 0.1$ Adc)		V <sub>CE(sat)</sub>	- -	2.0 3.0	Vdc
Base–Emitter Saturation Voltage( $I_C = 5.0$ Adc, $I_B = 0.01$ Adc) ( $I_C = 10$ Adc, $I_B = 0.1$ Adc)		V <sub>BE(sat)</sub>	_ _	2.8 4.5	Vdc
DYNAMIC CHARACTERISTICS					
Current Gain – Bandwidth Product (I <sub>C</sub> = 1.0 Adc, V <sub>CE</sub> = 5.0 Vdc, f <sub>test</sub> = 1.0 MHz)		h <sub>fe</sub>	20	_	_
Output Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)		C <sub>ob</sub>	-	200	pF
Small–Signal Current Gain (I <sub>C</sub> = 1.0 Adc, V <sub>CE</sub> = 5.0 Vdc, f = 1.0 kHz)		h <sub>fe</sub>	1000	_	_

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- 1. Indicates JEDEC Registered Data.
- 2. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2%.

 $R_B$  &  $R_C$  varied to obtain desired current levels  $D_1,$  must be fast recovery types e.g.,  $1N5825 \text{ USED ABOVE } I_B \approx 100 \text{ mA} \\ \text{MSD6100 USED BELOW } I_B \approx 100 \text{ mA}$ 

FOR  $t_d$  AND  $t_r,\,D_1$  IS DISCONNECTED AND  $V_2$  = 0  $t_r,\,t_f\,\leq\,$  10 ns DUTY CYCLE = 1.0%

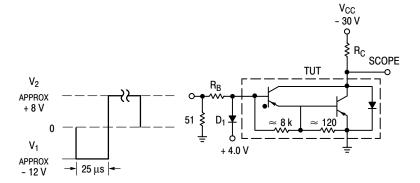


Figure 2. Switching Times Test Circuit

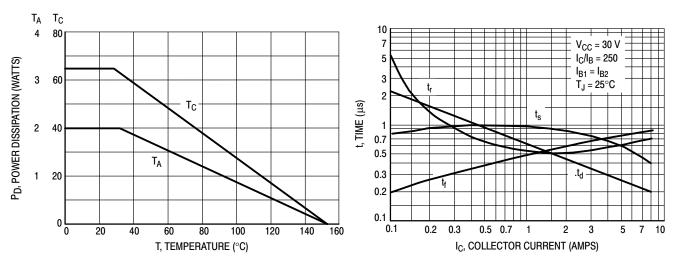


Figure 3. Power Derating

**Figure 4. Typical Switching Times** 

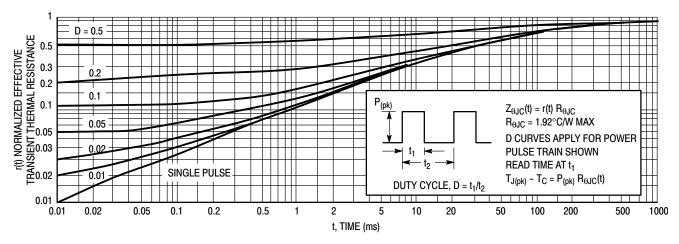


Figure 5. Thermal Response

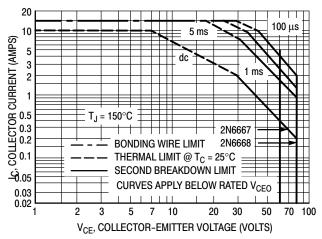


Figure 6. Maximum Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 6 is based on  $T_{J(pk)} = 150^{\circ} C$ ;  $T_C$  is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided  $T_{J(pk)} < 150^{\circ} C$ .  $T_{J(pk)}$  may be calculated from the data in Figure 5. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

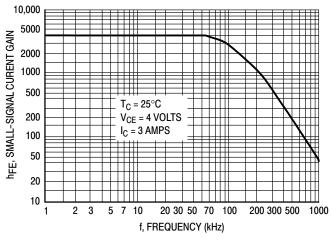


Figure 7. Typical Small-Signal Current Gain

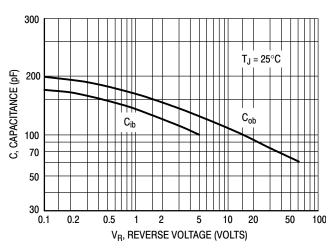


Figure 8. Typical Capacitance

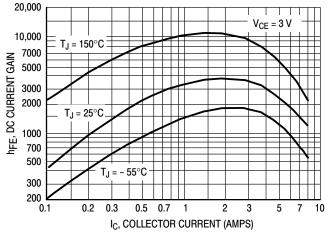


Figure 9. Typical DC Current Gain

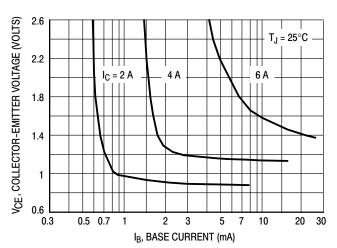
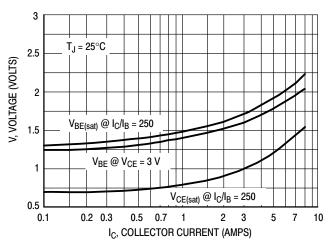


Figure 10. Typical Collector Saturation Region

### 2N6667, 2N6668



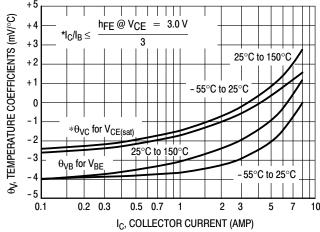


Figure 11. Typical "On" Voltages

**Figure 12. Typical Temperature Coefficients** 

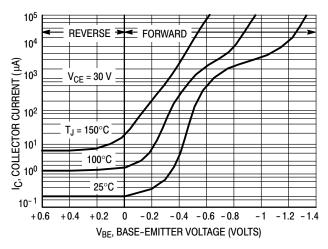


Figure 13. Typical Collector Cut-Off Region

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